

# 10V Drive Nch MOSFET

## RCJ330N25

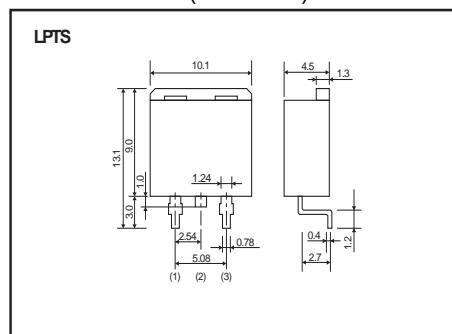
### ● Structure

Silicon N-channel MOSFET

### ● Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Gate-source voltage  
 $V_{GSS}$  guaranteed to be  $\pm 30V$ .
- 4) High package power.

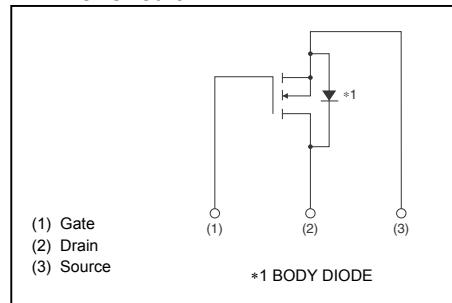
### ● Dimensions (Unit : mm)



### ● Application

Switching

### ● Inner circuit



### ● Absolute maximum ratings (Ta = 25°C)

Parameter	Symbol	Limits	Unit
Drain-source voltage	$V_{DSS}$	250	V
Gate-source voltage	$V_{GSS}$	$\pm 30$	V
Drain current	Continuous $I_D$ *3	$\pm 33$	A
	Pulsed $I_{DP}$ *1	$\pm 132$	A
Source current (Body Diode)	Continuous $I_S$ *3	26	A
	Pulsed $I_{SP}$ *1	104	A
Avalanche current	$I_{AS}$ *2	16.5	A
Avalanche energy	$E_{AS}$ *2	74.8	mJ
Power dissipation (Tc=25°C)	$P_D$	211	W
Channel temperature	Tch	150	°C
Range of storage temperature	Tstg	-55 to +150	°C

\*1  $P_w \leq 10\mu\text{s}$ , Duty cycle: 1%

\*2  $L = 500\mu\text{H}$ ,  $V_{DD} = 50V$ ,  $R_g = 25\Omega$ , starting Tch = 25°C

\*3 Limited only by maximum temperature allowed.

### ● Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to Case	$R_{th(j-c)}$ *	0.59	°C / W

\*  $T_c = 25^\circ\text{C}$

## ● Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	$I_{GSS}$	-	-	$\pm 100$	nA	$V_{GS}=\pm 30V, V_{DS}=0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	250	-	-	V	$I_D=1mA, V_{GS}=0V$
Zero gate voltage drain current	$I_{DSS}$	-	-	1	$\mu A$	$V_{DS}=250V, V_{GS}=0V$
Gate threshold voltage	$V_{GS(\text{th})}$	3	-	5	V	$V_{DS}=10V, I_D=1mA$
Static drain-source on-state resistance	$R_{DS(\text{on})^*}$	-	77	105	$m\Omega$	$I_D=16.5A, V_{GS}=10V$
Forward transfer admittance	$ Y_{fs} ^*$	10	20	-	S	$I_D=16.5A, V_{DS}=10V$
Input capacitance	$C_{iss}$	-	4500	-	pF	$V_{DS}=25V$
Output capacitance	$C_{oss}$	-	220	-	pF	$V_{GS}=0V$
Reverse transfer capacitance	$C_{rss}$	-	130	-	pF	$f=1MHz$
Turn-on delay time	$t_{d(on)}^*$	-	50	-	ns	$I_D=16.5A, V_{DD} \approx 125V$
Rise time	$t_r^*$	-	200	-	ns	$V_{GS}=10V$
Turn-off delay time	$t_{d(off)}^*$	-	120	-	ns	$R_L=7.6\Omega$
Fall time	$t_f^*$	-	140	-	ns	$R_G=10\Omega$
Total gate charge	$Q_g^*$	-	80	-	nC	$I_D=33A,$
Gate-source charge	$Q_{gs}^*$	-	25	-	nC	$V_{DD} \approx 125V$
Gate-drain charge	$Q_{gd}^*$	-	27	-	nC	$V_{GS}=10V$

\*Pulsed

## ● Body diode characteristics (Source-Drain) (Ta = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward Voltage	$V_{SD}^*$	-	-	1.5	V	$I_s=33A, V_{GS}=0V$

\*Pulsed

## ●Electrical characteristic curves (Ta=25°C)

Fig.1 Typical Output Characteristics ( I )

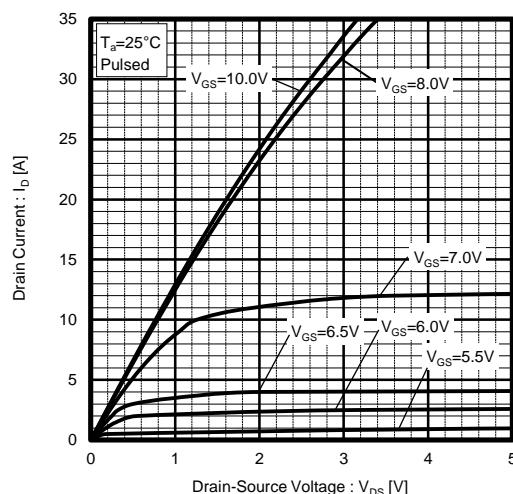


Fig.2 Typical Output Characteristics ( II )

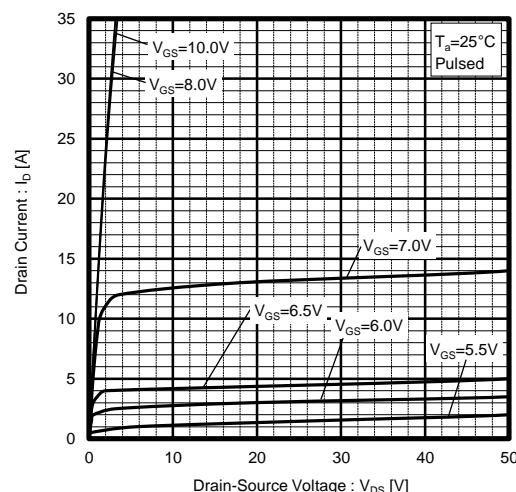


Fig.3 Typical Transfer Characteristics

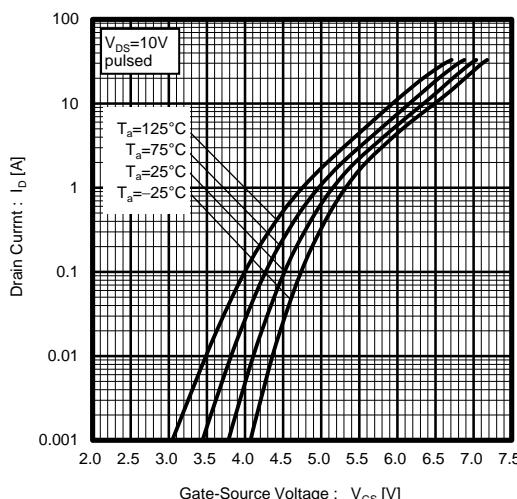


Fig.4 Gate Threshold Voltage vs. Channel Temperature

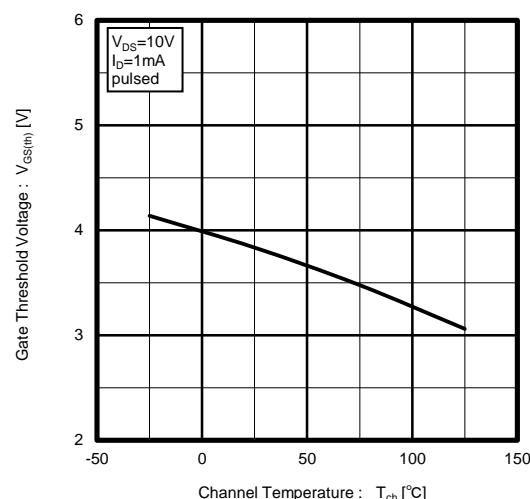


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

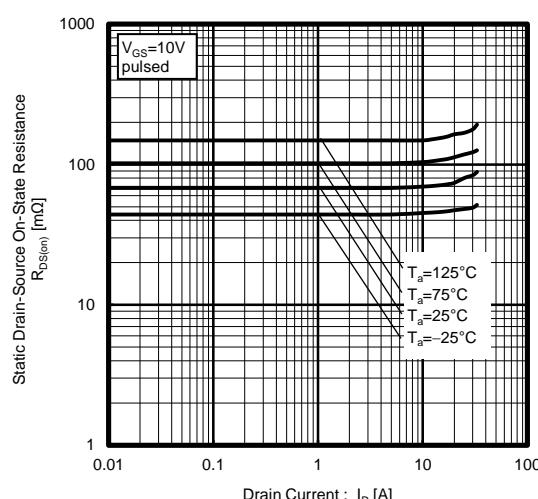


Fig.6 Static Drain-Source On-State Resistance vs. Channel Temperature

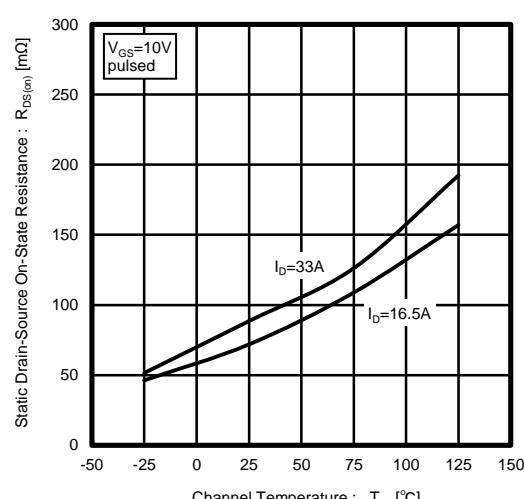


Fig.7 Forward Transfer Admittance vs. Drain Current

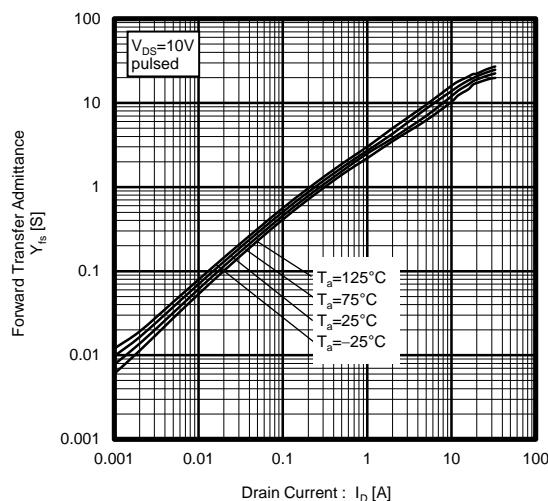


Fig.8 Source Current vs. Source-Drain Voltage

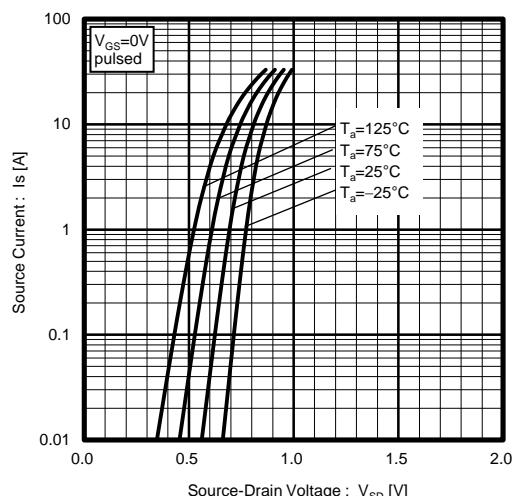


Fig.9 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

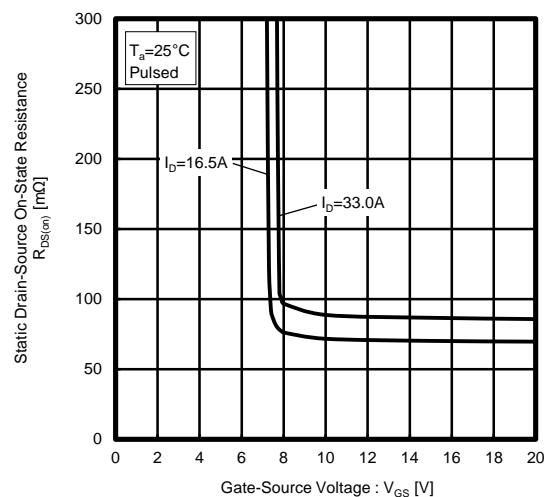


Fig.10 Switching Characteristics

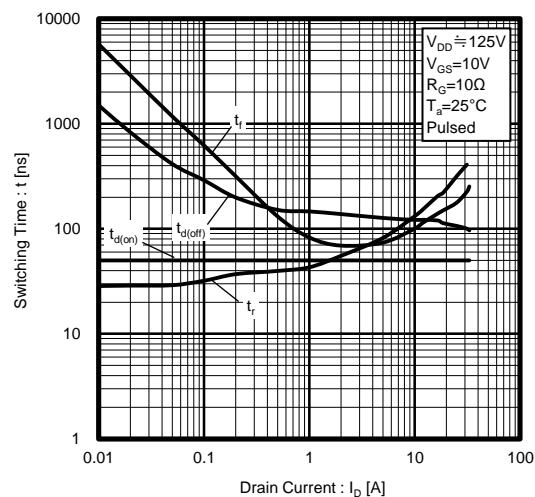


Fig.11 Dynamic Input Characteristics

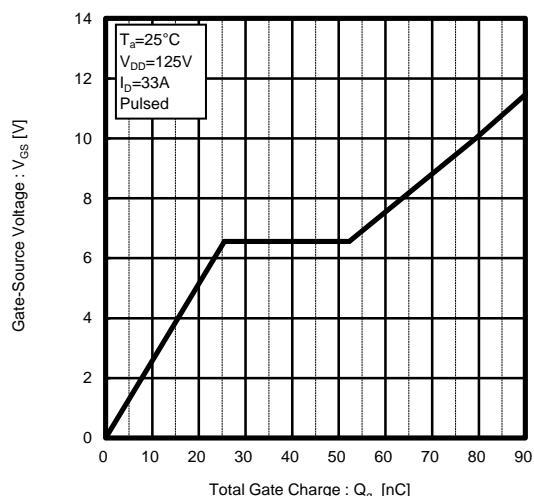


Fig.12 Typical Capacitance vs. Drain-Source Voltage

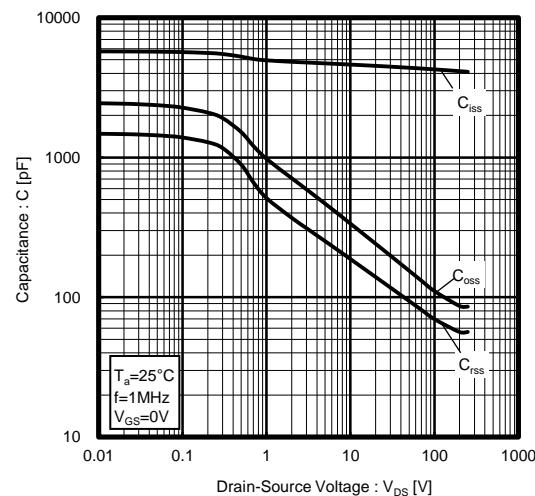


Fig.13 Maximum Safe Operating Area

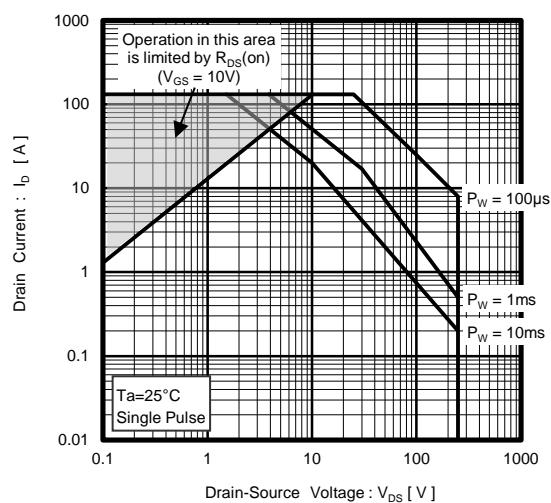
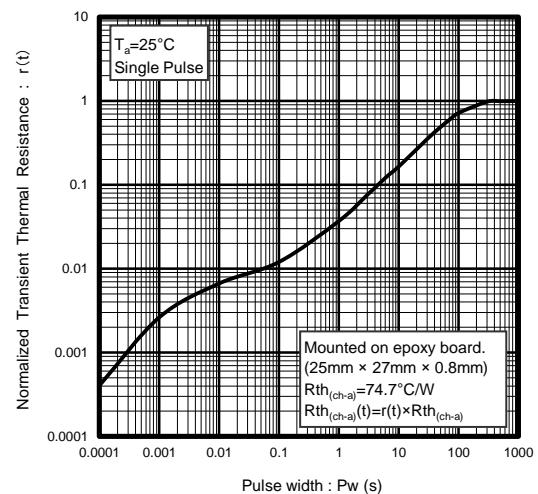


Fig.14 Normalized Transient Thermal Resistance v.s. Pulse Width



## ● Measurement circuits

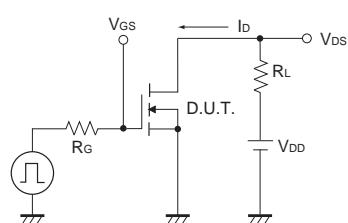


Fig.1-1 Switching Time Measurement Circuit

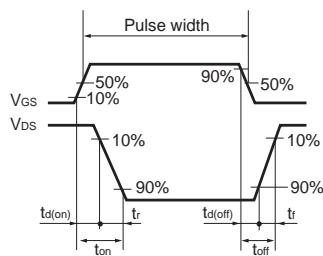


Fig.1-2 Switching Waveforms

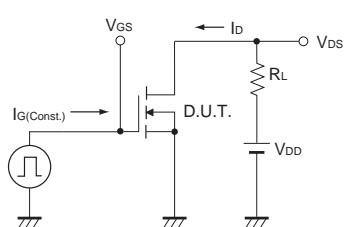


Fig.2-1 Gate Charge Measurement Circuit

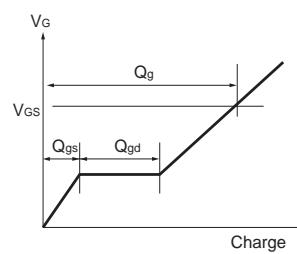


Fig.2-2 Gate Charge Waveform

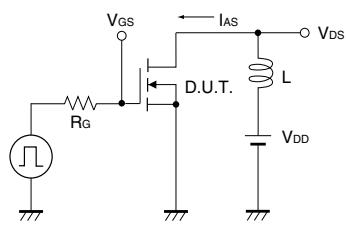


Fig.3-1 Avalanche Measurement Circuit

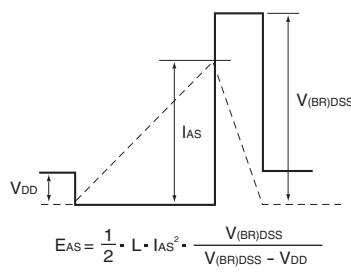


Fig.3-2 Avalanche Waveform

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CLASS IV		CLASS III	

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  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
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5. Please verify and confirm characteristics of the final or mounted products in using the Products.
6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
7. De-rate Power Dissipation (P<sub>d</sub>) depending on Ambient temperature (T<sub>a</sub>). When used in sealed area, confirm the actual ambient temperature.
8. Confirm that operation temperature is within the specified range described in the product specification.
9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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For details, please refer to ROHM Mounting specification

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## Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

## Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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